

# CGHV14800F1

## DC-1.4 GHz, 800 W GaN Transistor

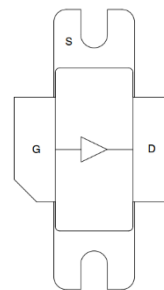
### Description

Wolfspeed's CGHV14800F1 is an 800W packaged, partially-matched transistor utilizing Wolfspeed's high performance, 0.4um GaN on SiC production process. The CGHV14800F1 operates up to 1.4 GHz and supports both defense and commercial-related avionics and radar applications. The CGHV14800F1 typically achieves 800 W of saturated output power with 14 dB of large signal gain and 65% drain efficiency via a 1.2-1.4 GHz reference design.

Packaged in a thermally-enhanced, flange package, the CGHV14800F1 provides superior performance under long pulse operation allowing customers to improve SWaP-C benchmarks in their next-generation systems.



**Figure 1. CGHV14800F1**



**Figure 2. Functional Block Diagram**

### Features

- Psat: 800 W
- DE: 65 %
- LSG: 14 dB
- S21: 18 dB
- S11: -12 dB
- S22: -5 dB
- Long pulse operation

### Applications

- Avionics - TACAN, DME, IFF
- L-band Radar
- General purpose amplification

Note: Features are typical performance via a 1.2-1.4 GHz reference design under 25C, pulsed operation (CGHV14800F1-AMP). Please reference performance charts for additional information.



## Absolute Maximum Ratings

Parameter	Symbol	Units	Value	Conditions
Drain Voltage	$V_d$	V	50	
Gate Voltage	$V_g$	V	-10 to +2	
Drain Current	$I_d$	A	24	
Gate Current	$I_g$	mA	133	
Input Power	$P_{in}$	dBm	47	
Dissipated Power	$P_{diss}$	W	545	85 °C, 2ms/20%
Storage Temperature	$T_{stg}$	°C	-65, +150	
Mounting Temperature	$T_J$	°C	260	30 seconds
Junction Temperature	$T_J$	°C	225	MTTF > 1E6
Output Mismatch Stress	VSWR	$\Psi$	5:1	
Pulse Width/Duty Cycle		$\mu s/\%$	2000/20	85C

## Recommended Operating Conditions

Parameter	Symbol	Units	Typical Value	Conditions
Drain Voltage	Vd	V	50	Pulsed only
Gate Voltage	Vg	V	-2.95	
Drain Current	Idq	mA	800	
Input Power	Pin	dBm	45	
Case Temperature	Tcase	°C	-40 to 85	

## RF Specifications (CGHV14800F1-AMP)

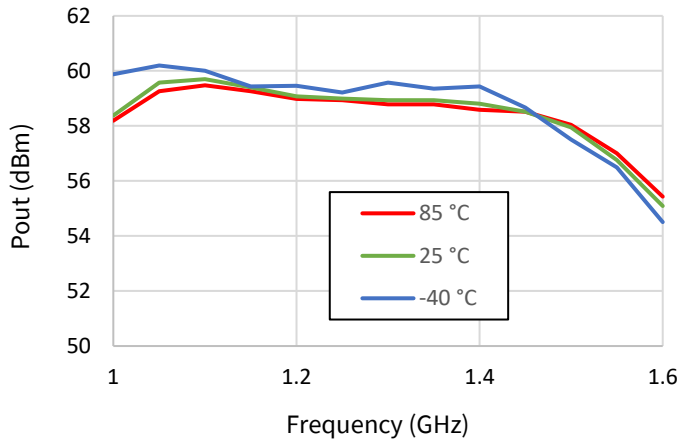
Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}=800mA$ ,  $PW=2ms$ ,  $DC=20\%$ ,  $T_{base}=25^\circ C$

Parameter	Units	Min	Typical	Max	Conditions
Frequency	GHz	1.2		1.4	
Output Power	dBm		59		Pin = 45 dBm
Drain Efficiency	%		65		Pin = 45 dBm
LSG	dB		14		Pin = 45 dBm
Small-Signal Gain (S21)	dB		18		
Input Return Loss (S11)	dB		-12		
Output Return Loss (S22)	dB		-5		

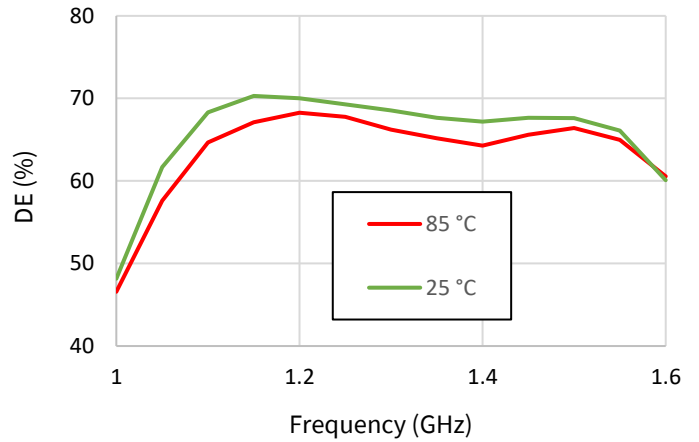
Note: Final testing and screening for all transistor sales is performed using the CGHV14800F1-AMP at 1.2-1.4 GHz.

Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}=800mA$ ,  $PW=2ms$ ,  $DC=20\%$ ,  $P_{in}=45dBm$ ,  $T_{base}=25^\circ C$ , Frequency = 1.4 GHz

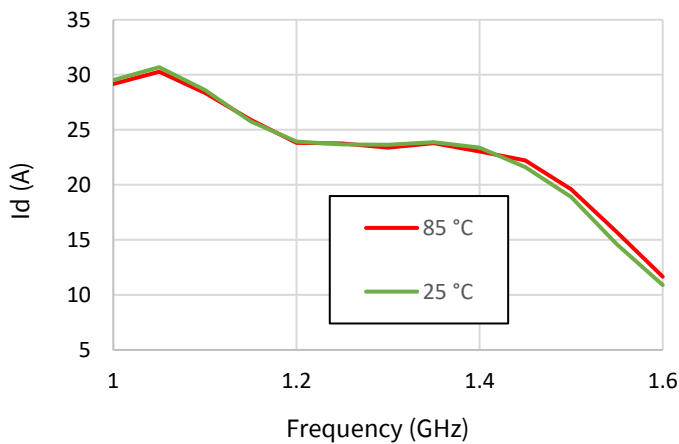
**Figure 3: Pout v. Frequency v. Temperature**



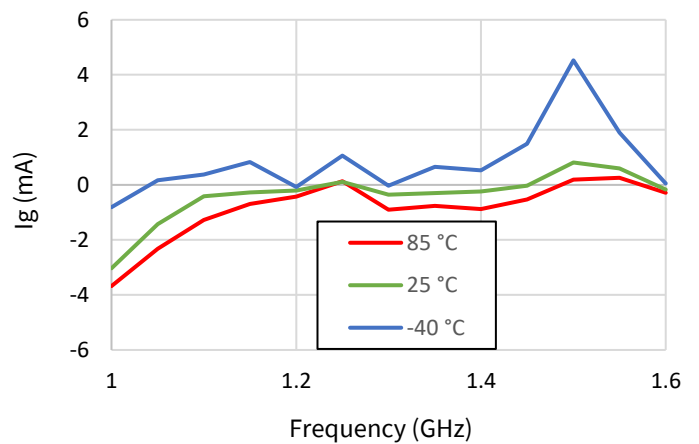
**Figure 4: DE v. Frequency v. Temperature**



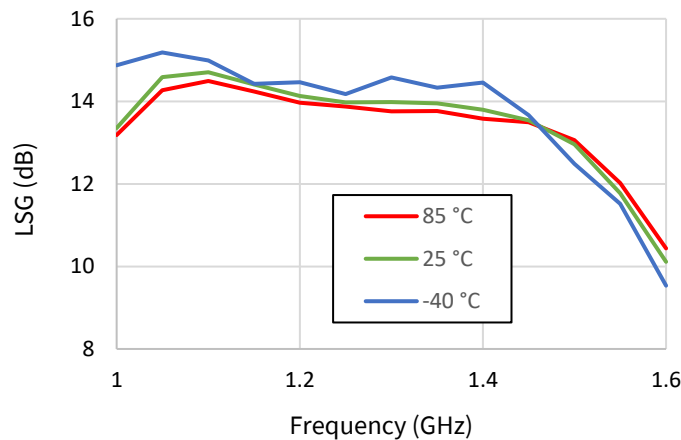
**Figure 5: Id v. Frequency v. Temperature**



**Figure 6: Ig v. Frequency v. Temperature**

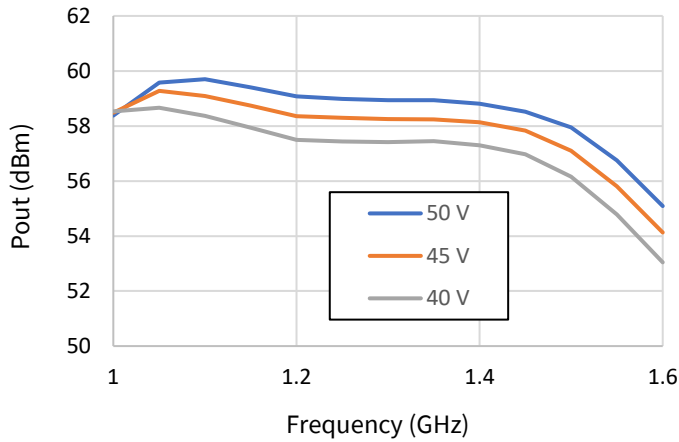


**Figure 7: LSG v. Frequency v. Temperature**

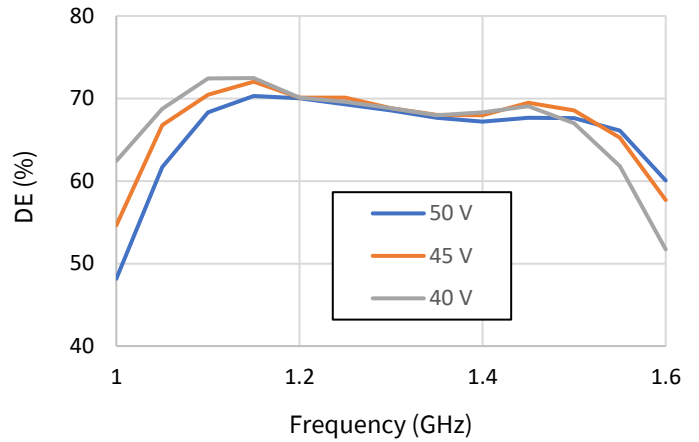


Test conditions unless otherwise noted: Vd=50V, Idq= 800mA, PW=2ms, DC=20%, Pin = 45dBm, T<sub>base</sub>=25 °C, Frequency =1.4 GHz

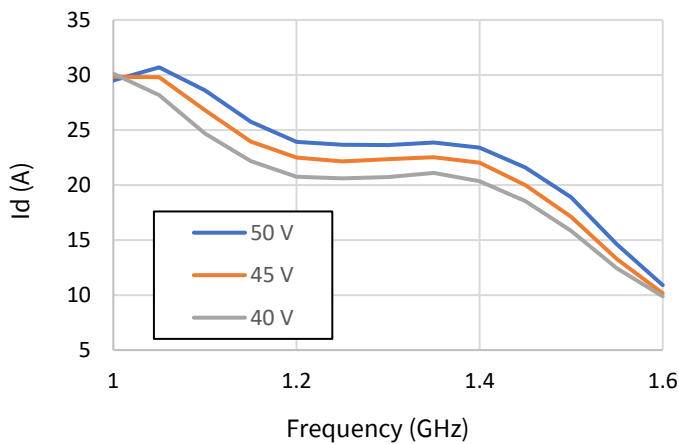
**Figure 8: Pout v. Frequency v. Vd**



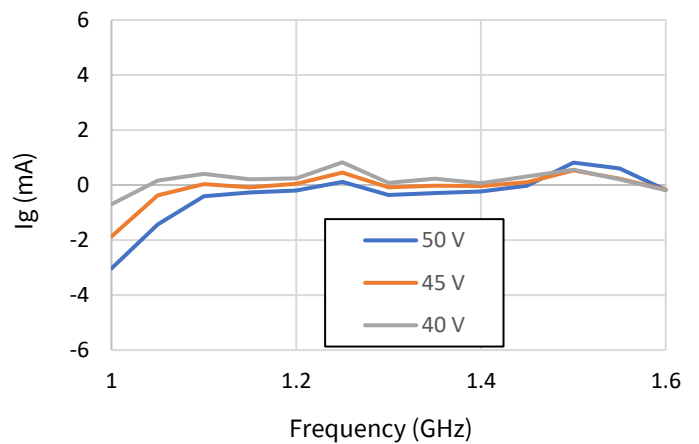
**Figure 9: DE v. Frequency v. Vd**



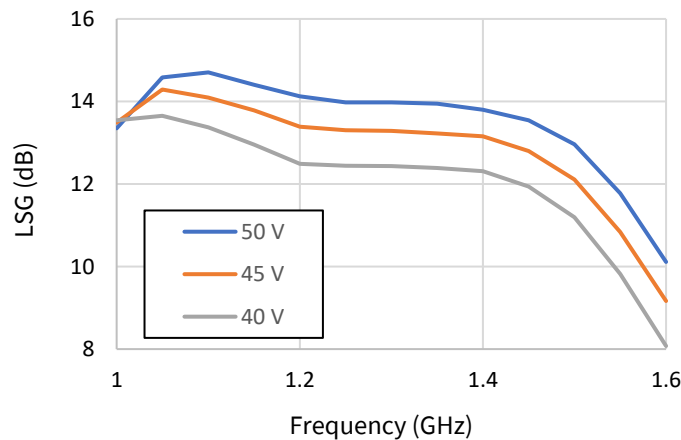
**Figure 10: Id v. Frequency v. Vd**



**Figure 11: Ig v. Frequency v. Vd**

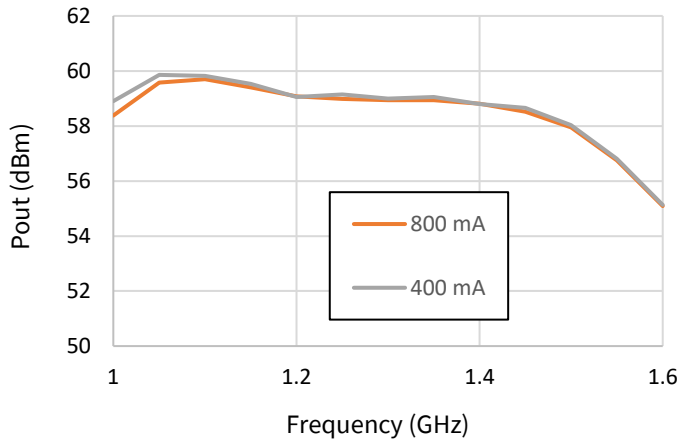


**Figure 12: LSG v. Frequency v. Vd**

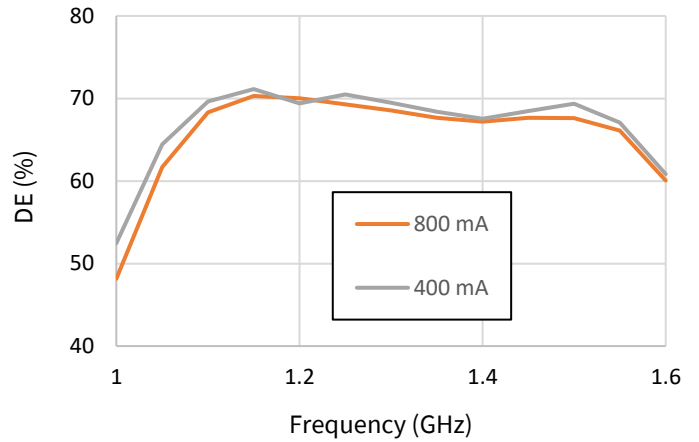


Test conditions unless otherwise noted: Vd=50V, Idq= 800mA, PW=2ms, DC=20%, Pin = 45dBm, T<sub>base</sub>=25 °C, Frequency =1.4 GHz

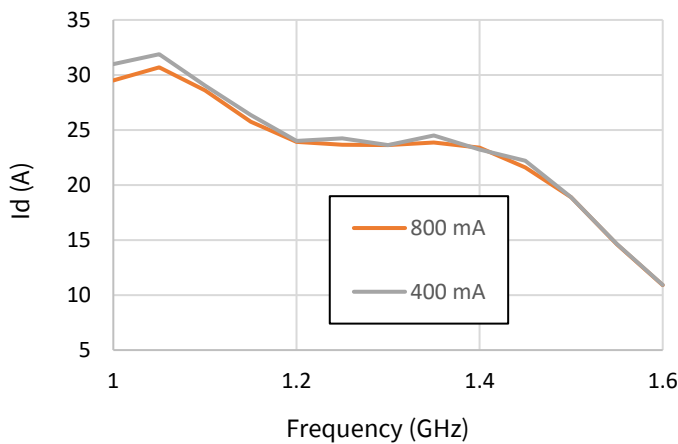
**Figure 13: Pout v. Frequency v. Idq**



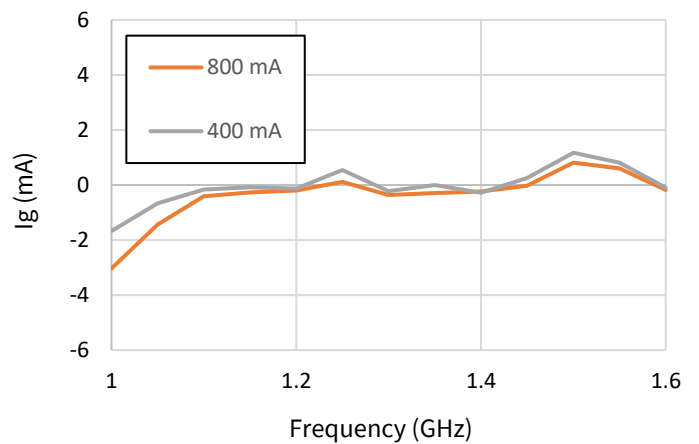
**Figure 14: DE v. Frequency v. Idq**



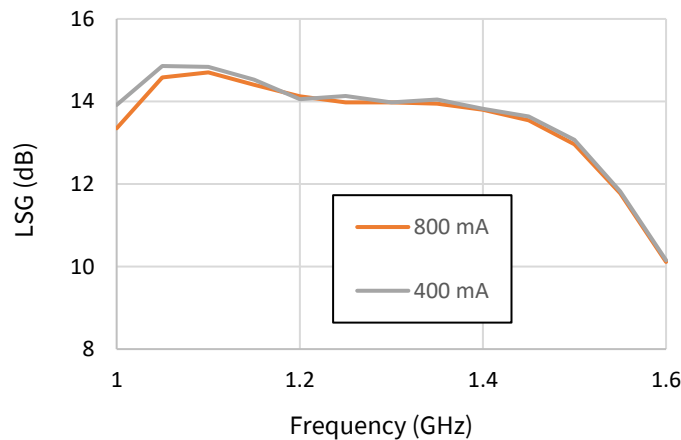
**Figure 15: Id v. Frequency v. Idq**



**Figure 16: Ig v. Frequency v. Idq**

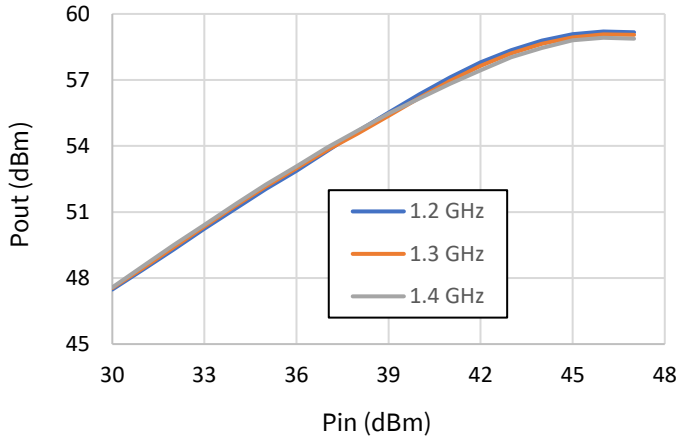


**Figure 17: LSG v. Frequency v. Idq**

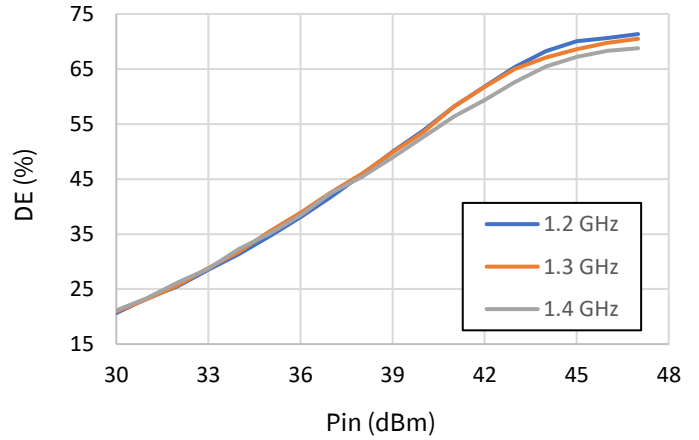


Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}=800mA$ ,  $PW=2ms$ ,  $DC=20\%$ ,  $P_{in}=45dBm$ ,  $T_{base}=25^\circ C$ , Frequency = 1.4 GHz

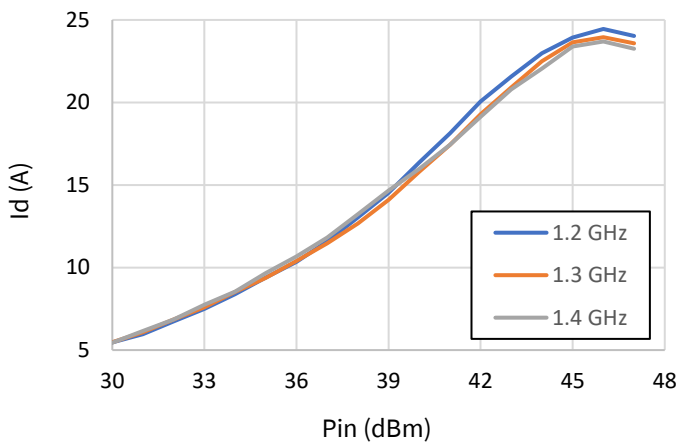
**Figure 18: Pout v. Pin v. Frequency**



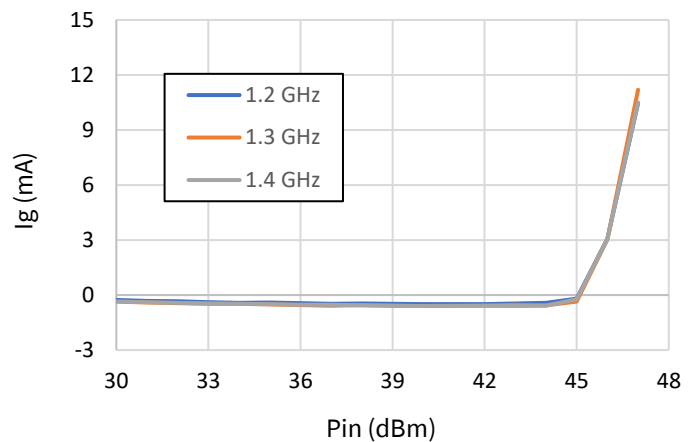
**Figure 19: DE v. Pin v. Frequency**



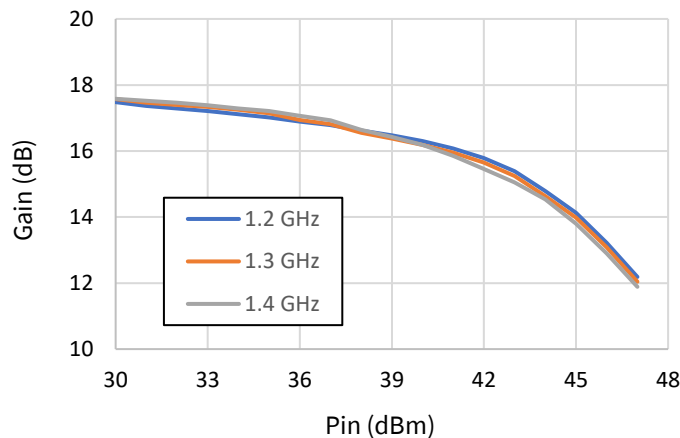
**Figure 20: Id v. Pin v. Frequency**



**Figure 21: Ig v. Pin v. Frequency**

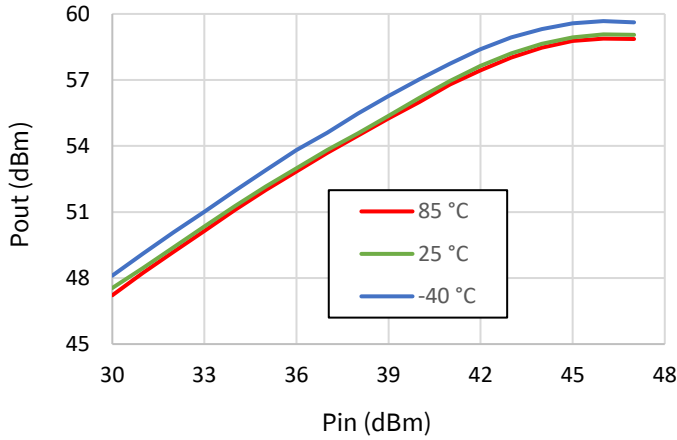


**Figure 22: Gain v. Pin v. Frequency**

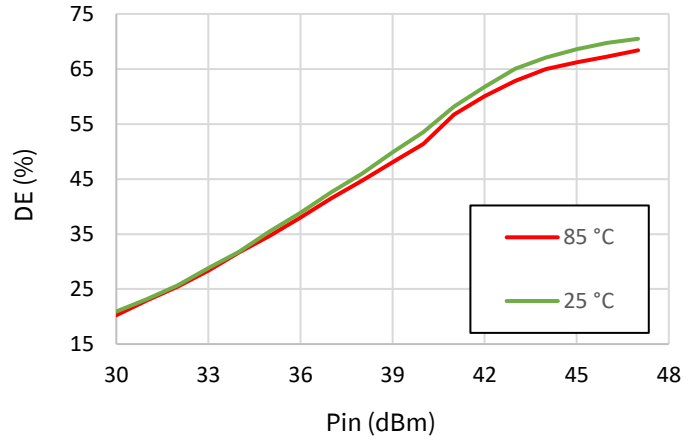


Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}=800mA$ ,  $PW=2ms$ ,  $DC=20\%$ ,  $P_{in}=45dBm$ ,  $T_{base}=25^\circ C$ , Frequency =1.4 GHz

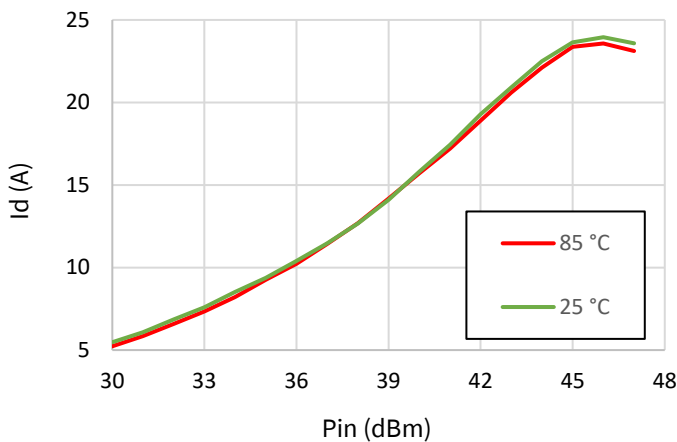
**Figure 23: Pout v. Pin v. Temperature**



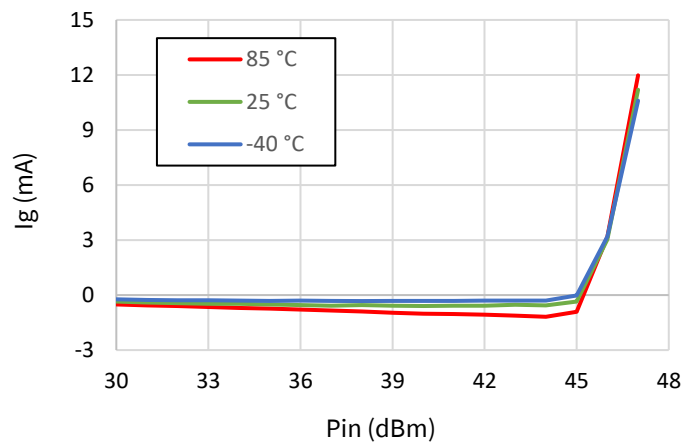
**Figure 24: DE v. Pin v. Temperature**



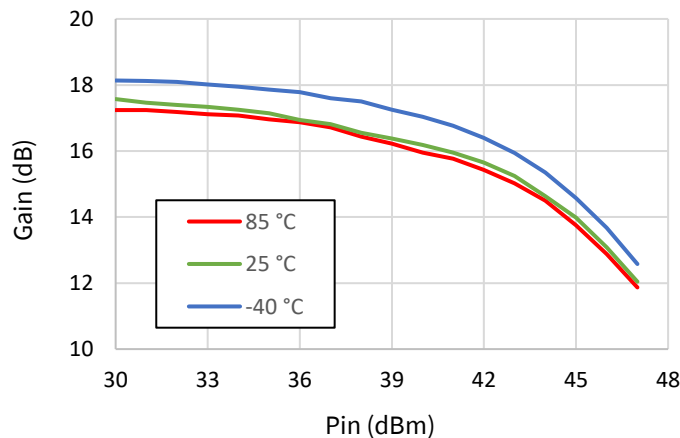
**Figure 25: Id v. Pin v. Temperature**



**Figure 26: Ig v. Pin v. Temperature**

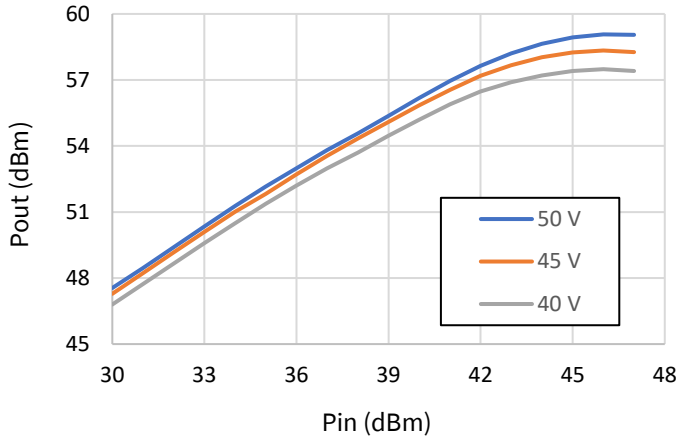


**Figure 27: Gain v. Pin v. Temperature**

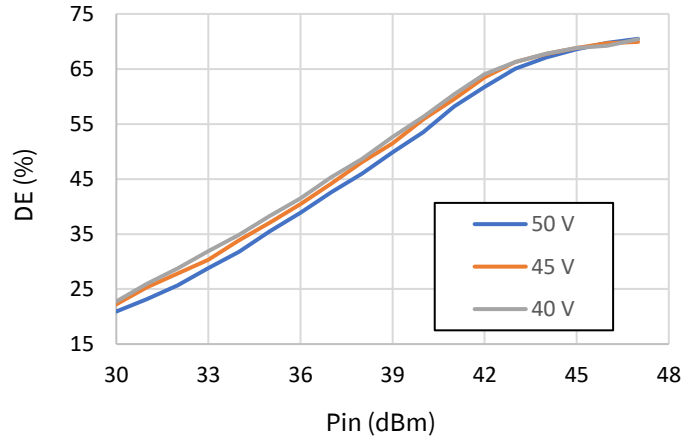


Test conditions unless otherwise noted: Vd=50V, Idq= 800mA, PW=2ms, DC=20%, Pin = 45dBm, T<sub>base</sub>=25 °C, Frequency =1.4 GHz

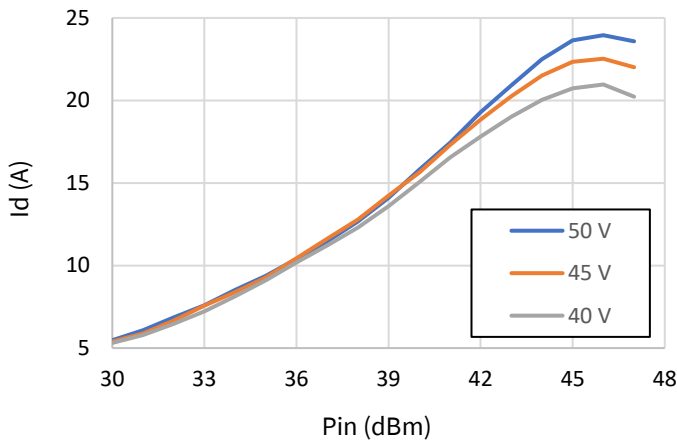
**Figure 28: Pout v. Pin v. Vd**



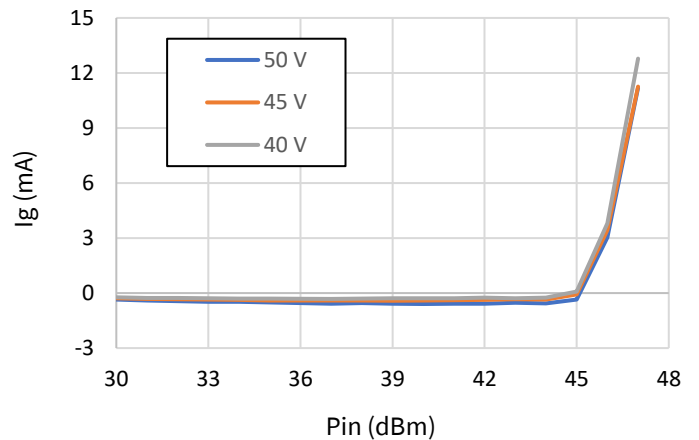
**Figure 29: DE v. Pin v. Vd**



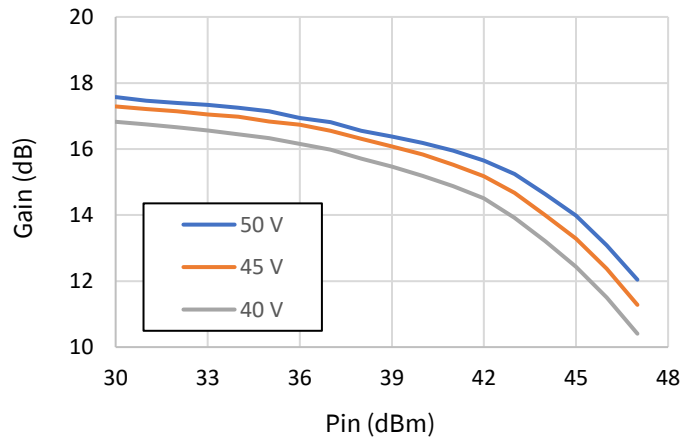
**Figure 30: Id v. Pin v. Vd**



**Figure 31: Ig v. Pin v. Vd**



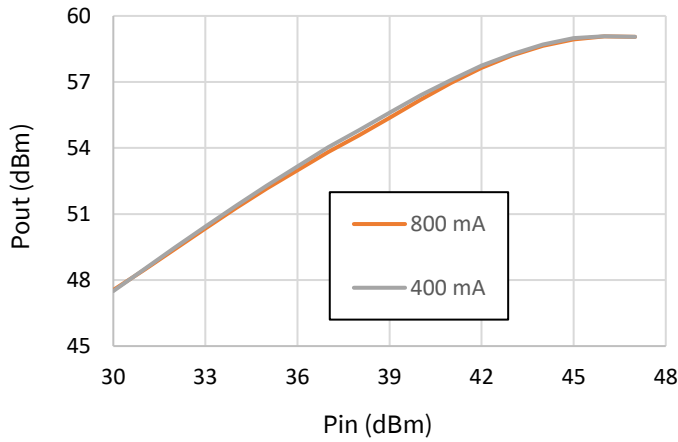
**Figure 32: Gain v. Pin v. Vd**



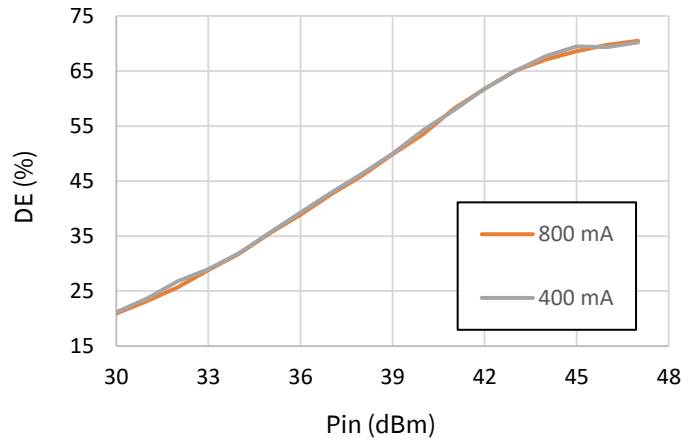


Test conditions unless otherwise noted: Vd=50V, Idq= 800mA, PW=2ms, DC=20%, Pin = 45dBm, T<sub>base</sub>=25 °C, Frequency =1.4 GHz

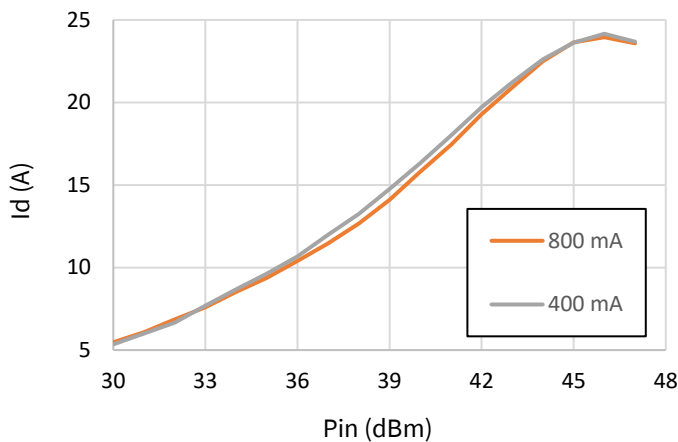
**Figure 33: Pout v. Pin v. Idq**



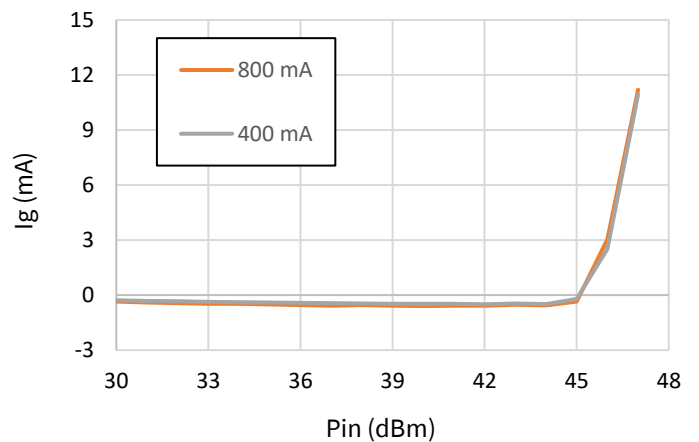
**Figure 34: DE v. Pin v. Idq**



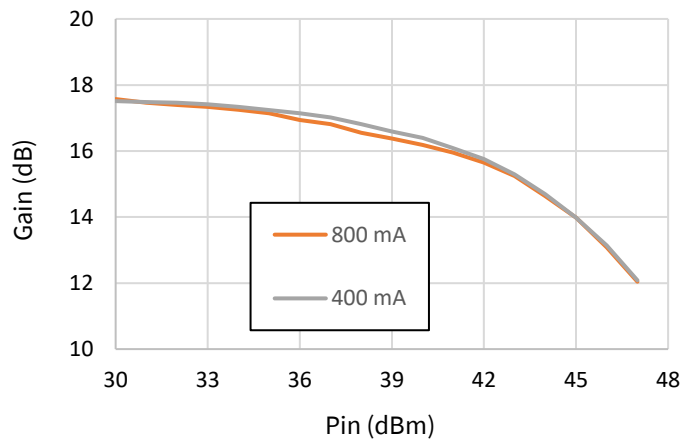
**Figure 35: Id v. Pin v. Idq**



**Figure 36: Ig v. Pin v. Idq**

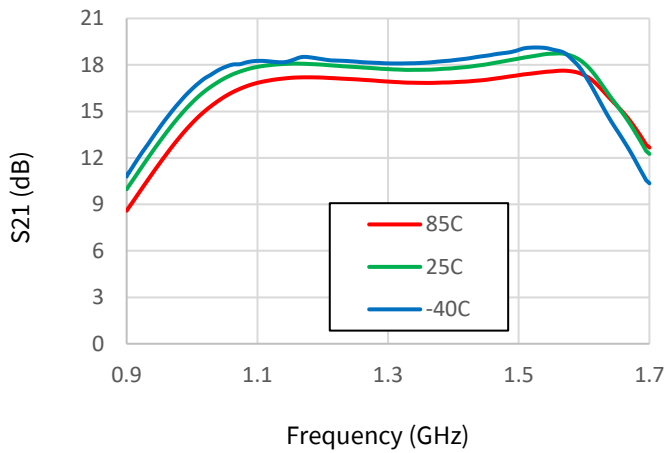


**Figure 37: Gain v. Pin v. Idq**

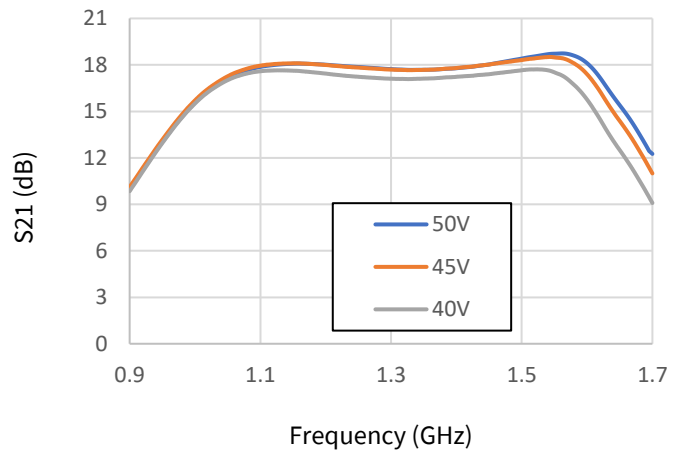


Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}= 800mA$ ,  $P_{in} = -20 \text{ dBm}$ ,  $T_{base}=25^\circ\text{C}$

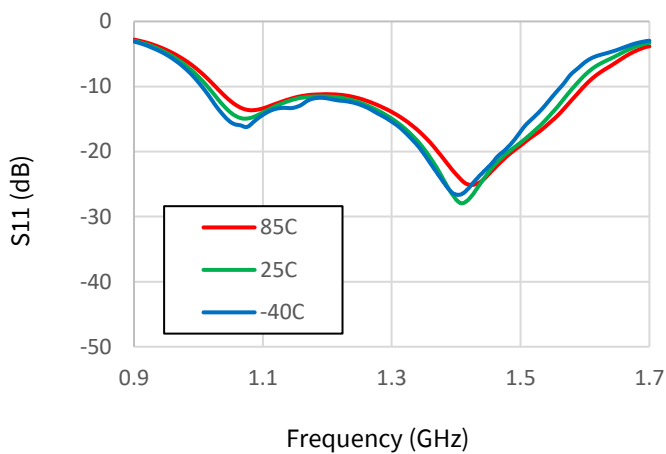
**Figure 38: S21 v. Frequency v. Temperature**



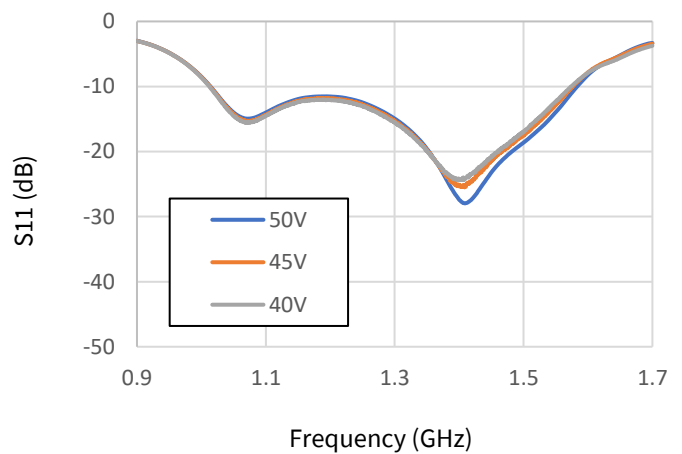
**Figure 39: S21 v. Frequency v. Vd**



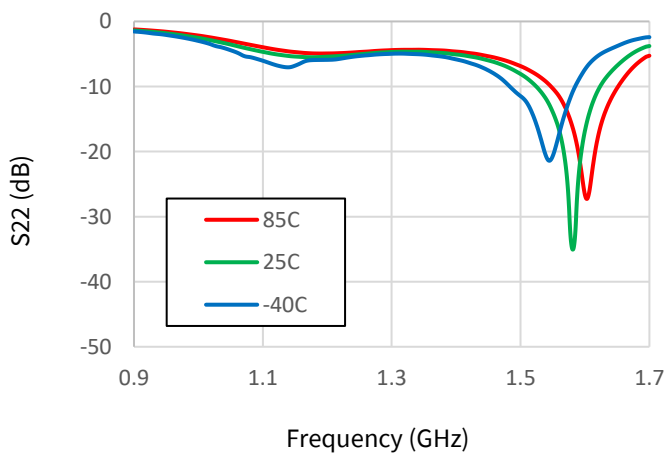
**Figure 40: S11 v. Frequency v. Temperature**



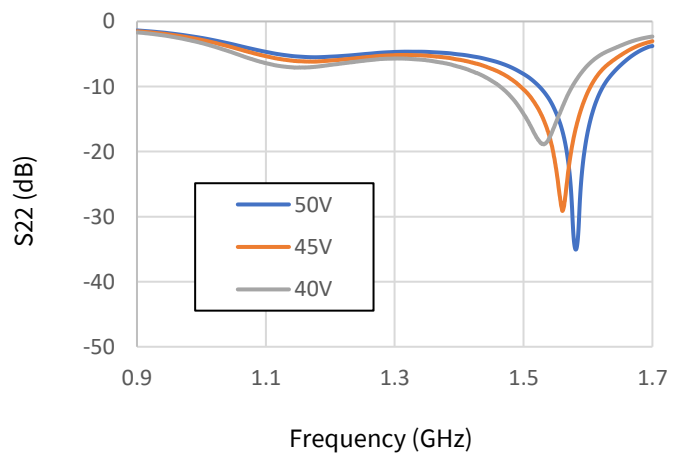
**Figure 41: S11 v. Frequency v. Vd**



**Figure 42: S22 v. Frequency v. Temperature**

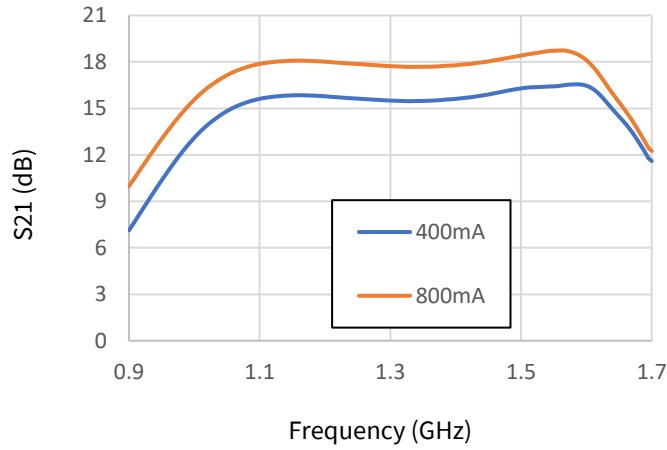


**Figure 43: S22 v. Frequency v. Vd**

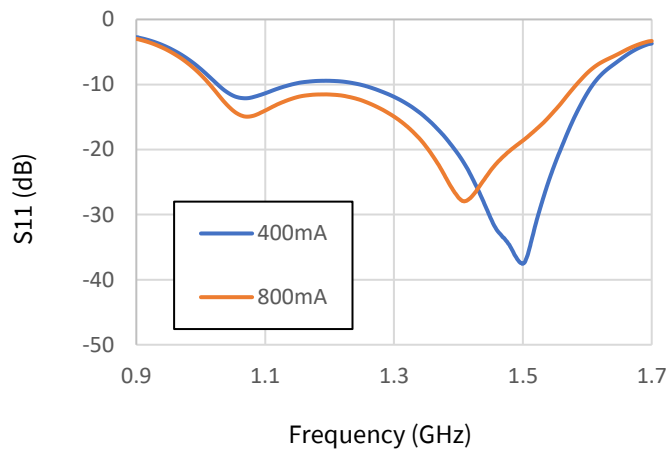


Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}= 800mA$ ,  $P_{in} = -20\text{ dBm}$ ,  $T_{base}=25\text{ }^\circ\text{C}$

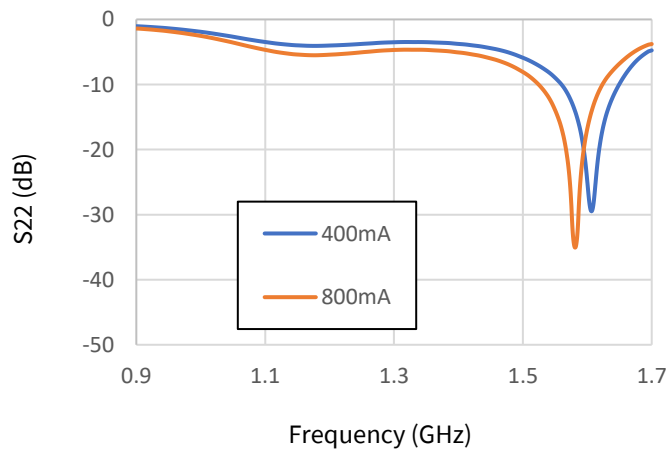
**Figure 44: S21 v. Frequency v. Idq**



**Figure 45: S11 v. Frequency v. Idq**

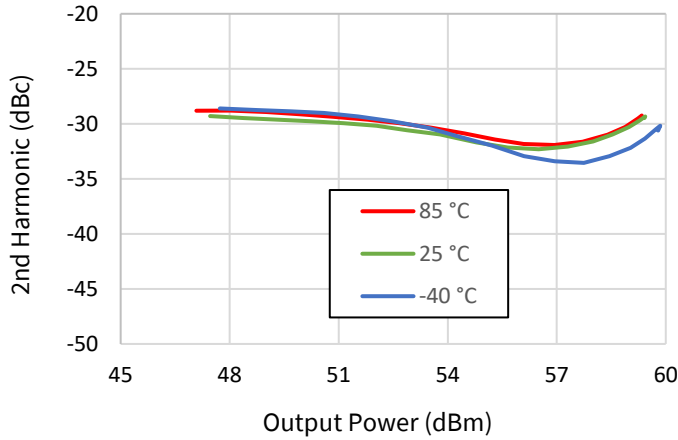


**Figure 46: S22 v. Frequency v. Idq**

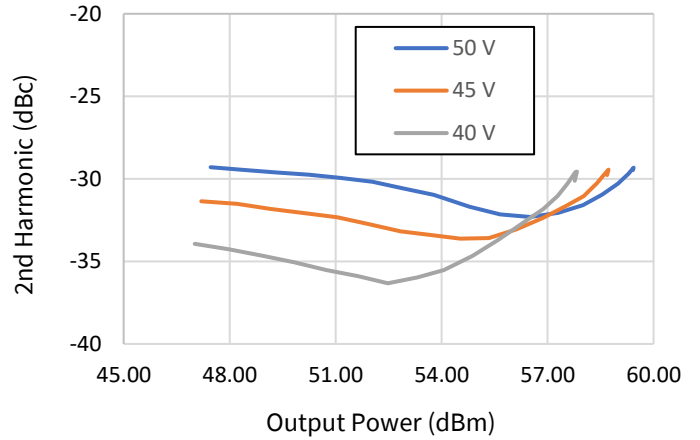


Test conditions unless otherwise noted:  $V_d=50V$ ,  $I_{dq}=800mA$ ,  $PW=2ms$ ,  $DC=20\%$ ,  $P_{in}=45dBm$ , Frequency 1= 1.2 GHz, Frequency 2 = 1.3 GHz, Frequency 3 = 1.4 GHz,  $T_{base}=25^\circ C$

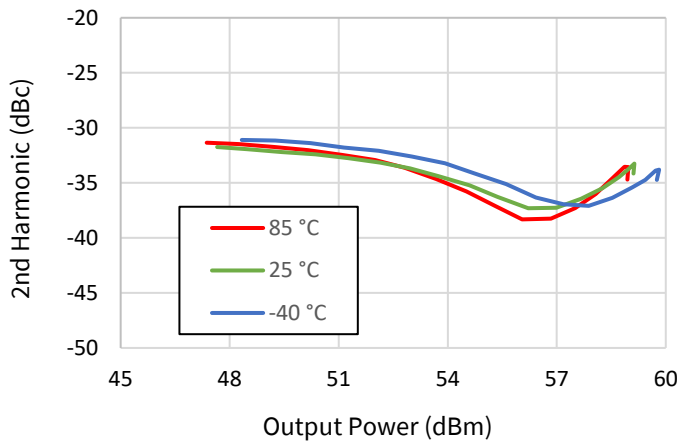
**Figure 53: f/2 v. Pout v. Temperature, F1**



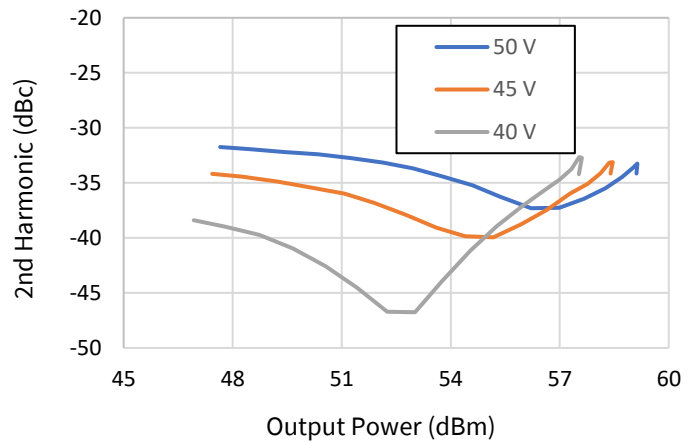
**Figure 54: f/2 v. Pout v. Vd, F1**



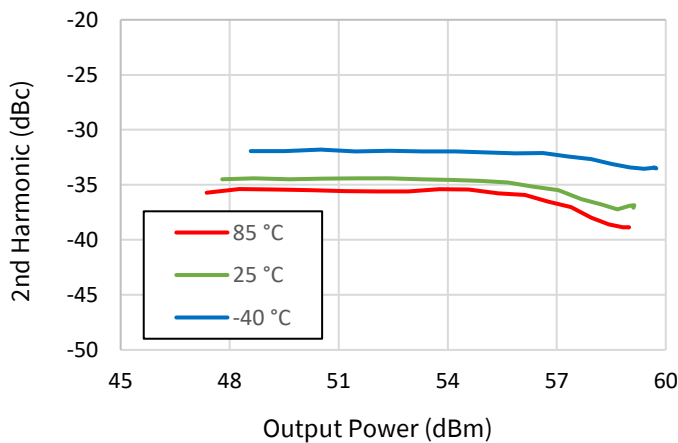
**Figure 55: f/2 v. Pout v. Temperature, F2**



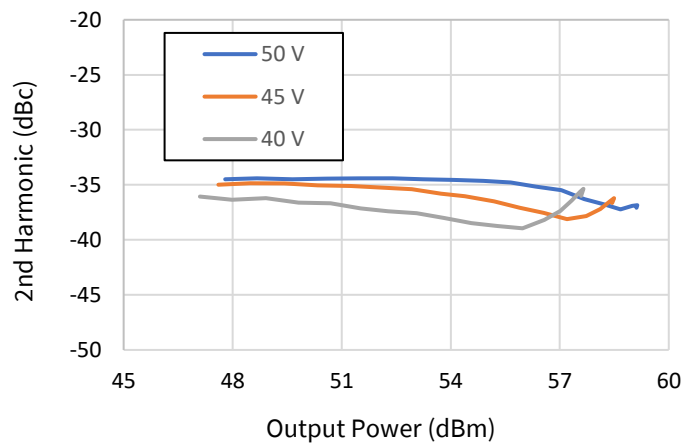
**Figure 56: f/2 v. Pout v. Vd, F2**



**Figure 57: f/2 v. Pout v. Temperature, F3**



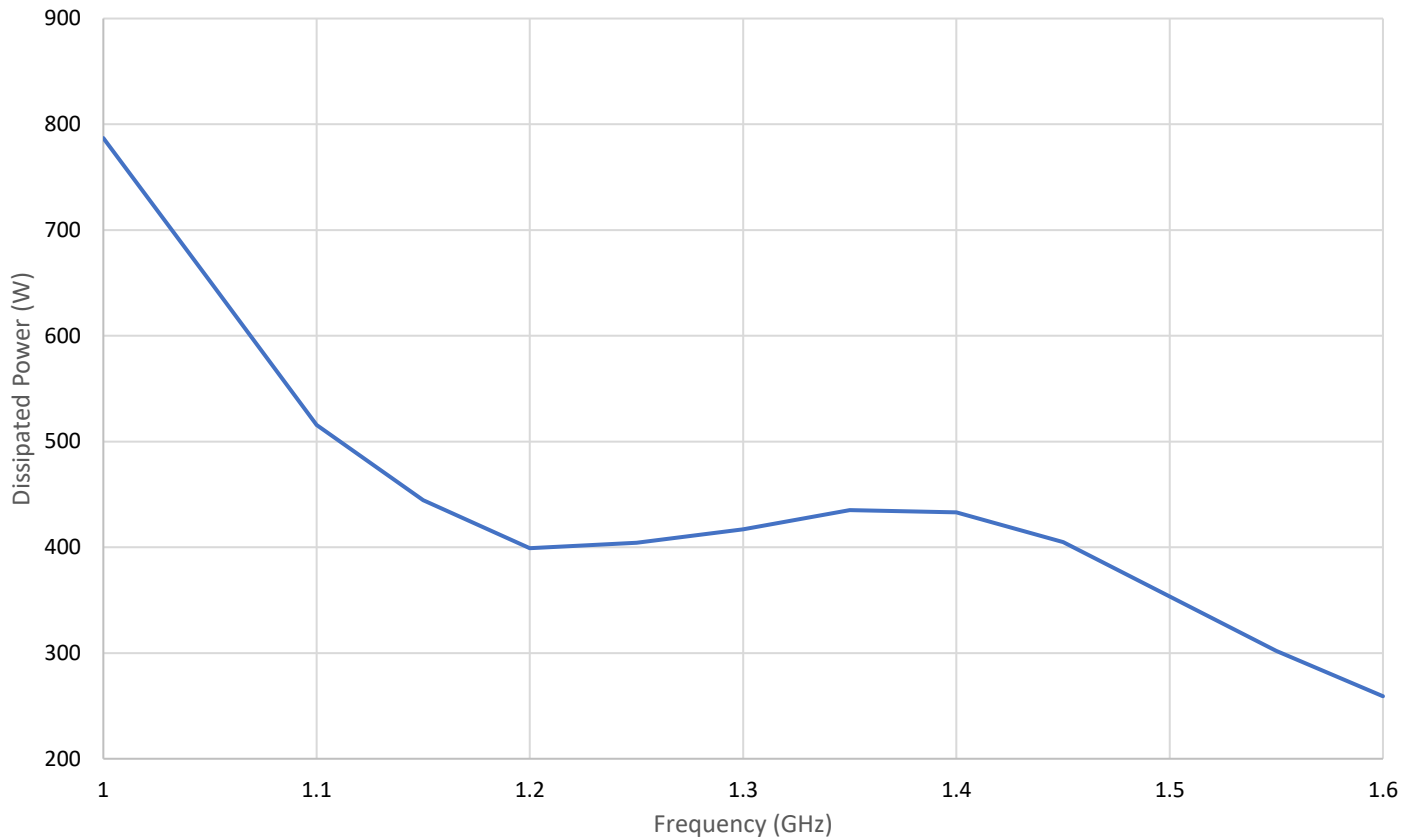
**Figure 58: f/2 v. Pout v. Vd, F3**



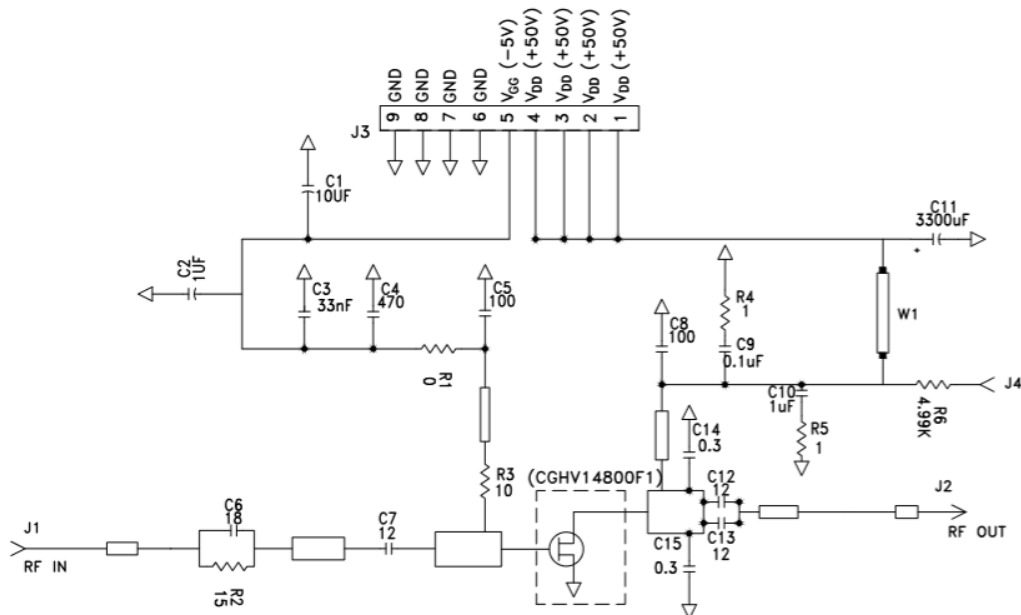
### Thermal Characteristics

Parameter	Symbol	Value	Operating Conditions
Operating Junction Temperature	$T_J$	198	Freq = 1.4 GHz, $V_d = 50$ V, $I_{dq} = 800$ mA, $I_{drive} = 23.0$ A , $P_{in} = 45$ dBm, $P_{out} = 58.6$ dBm, $P_{diss} = 433$ W, $T_{case} = 85^\circ\text{C}$ , PW = 2ms, DC = 20%
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.26	

### Power Dissipation v. Frequency ( $T_{case} = 85^\circ\text{C}$ )



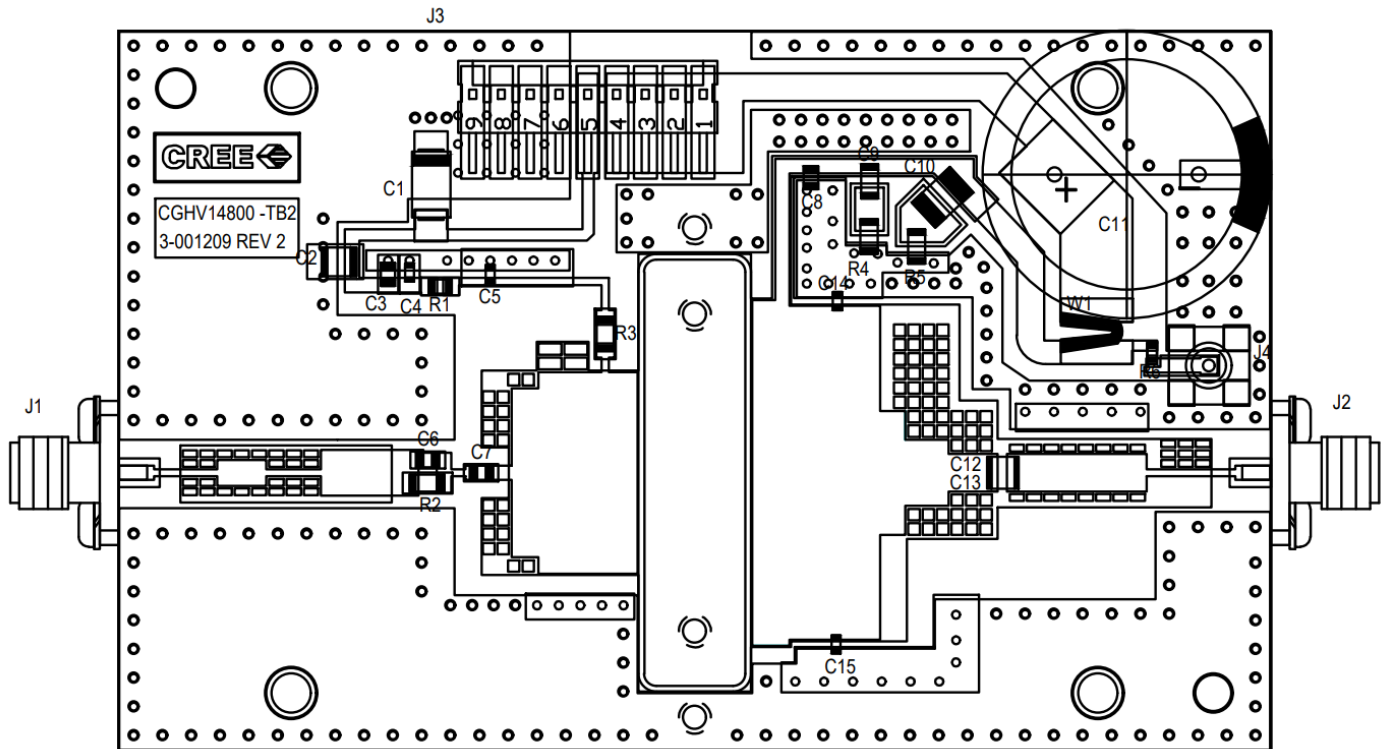
### CGHV14800F1-AMP Evaluation Board Schematic Drawing



### CGHV14800F1-AMP Evaluation Board Bill of Materials

Reference Designator	Description	Qty
R1	RES, 1/8W, 1206, 5%, 0 OHMS	1
R2	RES, 1/8W, 1206, 5%, 15 OHMS	1
R3	RES, 1/8W, 1206, 5%, 10 OHMS	1
R4,R5	RES, 1/8W, 1206, 5%, 1 OHMS	2
R6	RES,1/16W,0603,1%,4.99K OHMS	1
C1	CAP 10UF 16V TANTALUM	1
C2, C10	CAP, 1.0UF, 100V, 10%, X7R, 1210	2
C3	CAP,33000PF, 0805,100V, X7R	1
C4	CAP, 470pF, 0805, 100V, C0G	1
C5, C8	CAP, 100PF, +/-5%, 250V, 0805, ATC 600F	2
C6	CAP, 18pF, +/-5%, 250V, 0603, ATC 600S	1
C7	CAP, 12 PF, +/- 5%, 250V, 0805, ATC 600F	1
C9	CAP, 0.1uF, +/- 10%, 100V, 1206, 1206	1
C11	CAP, 3300 UF, +/-20%, 100V, ELECTROLYTIC	1
C12, C13	CAP, 12PF, +/- 2%,500V, ATC800B	2
C14, C15	CAP, 0.3PF, +/- 0.05pF, 0603, ATC	2
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
J4	CONNECTOR; SMB, Straight, JACK, SMD	1
W1	CABLE ,18 AWG, 4.2"	1
	PCB, Rogers 3010, 0.025" THK, CGHV14800 1.2-1.4GHZ	1
	BASEPLATE, COPPER, 4.00 X 2.50 X 0.49, ALTERNATE HOLE PATTERN	1
	2-56 SOC HD SCREW 1/4 SS	4
	#2 SPLIT LOCKWASHER SS	4
	Indium Foil in channel (0.0002" thick)	

## CGHV14800F1-AMP Evaluation Board Assembly Drawing



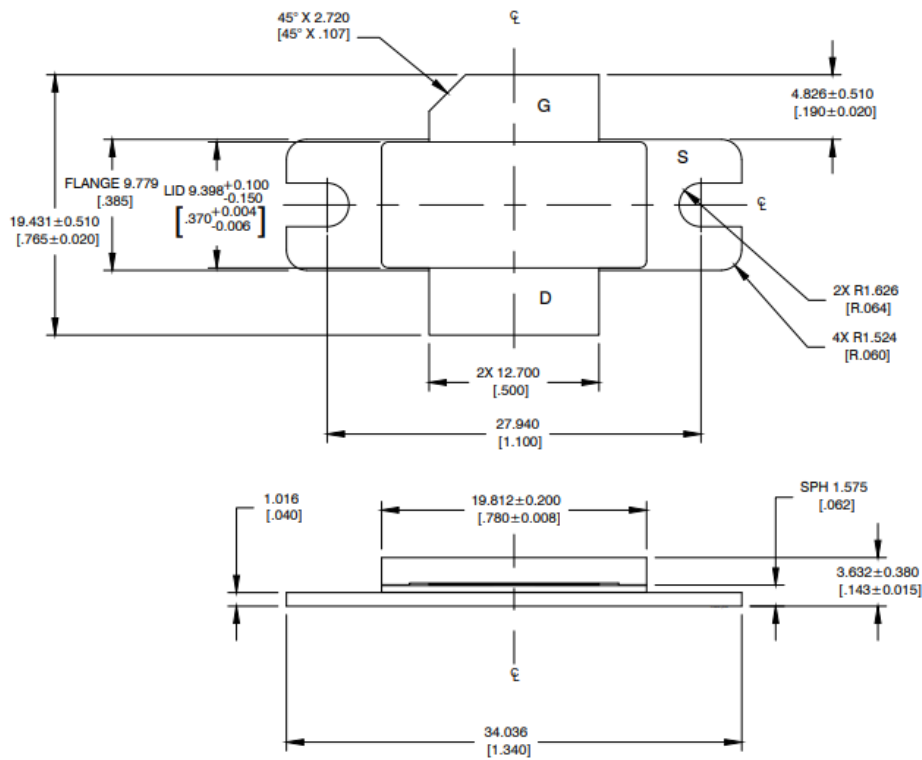
### Bias On Sequence

1. Ensure RF is turned-off
2. Apply pinch-off voltage of -5 V to the gate ( $V_g$ )
3. Apply nominal drain voltage ( $V_d$ )
4. Adjust  $V_g$  to obtain desired quiescent drain current ( $I_{dq}$ )
5. Apply RF

### Bias Off Sequence

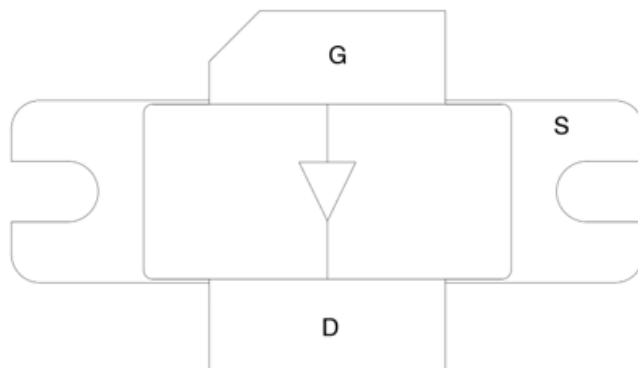
1. Turn RF off
2. Apply pinch-off to the gate ( $V_g = -5V$ )
3. Turn off drain voltage ( $V_d$ )
4. Turn off gate voltage ( $V_g$ )

**Product Dimensions**



NOTES: UNLESS OTHERWISE SPECIFIED

1. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
2. PINS: D=DRAIN  
S=SOURCE (FLANGE)  
G=GATE
3. LEAD THICKNESS: 0.10<sup>+0.051</sup><sub>-0.025</sub> [.004<sup>+0.002</sup><sub>-.001</sub>]
4. PLATING (GOLD TOP LAYER): 1.14 ± 0.38 MICRON [45 ± 15 MICROINCH].
5. THE CONTENTS OF THIS DRAWING ARE INTENDED TO REPRESENT THE PRODUCT IN MARKETING GRAPHICS ONLY, AND NOT INTENDED TO BE USED FOR ANY PRODUCTION OR INTERNAL QUALIFICATION PURPOSE.




Pin	Description
D	Drain Device
G	Gate Device
S	Source (Flange)



## Electrostatic Discharge (ESD) Classification

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

## Product Ordering Information

Part Number	Description	MOQ Increment	Image
CGHV14800F1	DC – 1.4 GHz, 800W GaN Transistor	1 Each	
CGHV14800F1-AMP	1.2-1.4 GHz Evaluation Board	1 Each	

For more information, please contact:

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